SEMTECH

POWER MANAGEMENT

Absolute Maximum Ratings

Exceeding the specifications below may result in permanent damage to the device, or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not implied.

Parameter	Symbol	Maximum	Units
Input Voltage	V_{IN} to GND	-0.3 to 20	V
Storage Temperature Range	T_{STG}	-45 to +150	°C
Maximum Junction Temperature	T_J	150	°C
Lead Temperature (Soldering) 10 Sec.	T_{LEAD}	300	°C
Thermal Resistance, Junction to Ambient[1]	θ_{JA}	165	°C/W
Thermal Resistance, Junction to Case	θ_{JC}	102	°C/W
Electrical Surge Discharge[2]	ESD	2	KV

Note:
(1) Mounting pad has to be larger than one square inch on two sided printed circuit board with minimum 1 ounce copper
(2) Human model.

Electrical Characteristics

V_{IN}= 12V; V_O = 25V; T_A = T_J = -40°C to 125°C unless otherwise specified.

Parameter	Symbols	Conditions	Min	Typ	Max	Units
Reference	V_{REF}		1.225	1.250	1.275	V
Feedback Bias Current	I_{FB}	V_{FB} = $V_{EN/SS}$, V_{IN} = 12V		2.0	8.0	µA
Quiescent Current	I_Q	Current into V_{IN} pin		5.0	8.0	mA
Load Regulation		V_O=25V ; I_O = 0.1A to 1A		0.5	1.0	%
Line Regulation		V_{IN}=5V to 15V ; V_O=25V ; I_O = 100mA		1.4	2	%
Current Limit Threshold		CS	68	73	78	mV
Oscillator Frequency		T_A = 25°C	190	200	210	kHz
Oscillator Frequency Shift		V_{FB} < V_{REF}/2		50		kHz
Max Duty Cycle			90	95		%
UVLO Threshold	V_{UVLO}	V_{IN} ramping up		4.2	4.5	V
UVLO Hysteresis				400		mV
Driver Source Current	I_{SOURCE}	V_{IN} = 12V, C_{GATE} = 10nF	0.5	0.8	1.1	A
Driver Sink Current	I_{SINK}	V_{IN} = 12V, C_{GATE} = 10nF	0.5	0.8	1.1	A
Soft Start Charge Current	I_{SS}			60		µA
Internal Ramp Peak	V_{R_PEAK}			1.4		V
Internal Ramp Valley	V_{R_VALLEY}			0.4		V
Enable Threshold	V_{TH_EN}	Pull down below this level to disable the output	0.09	0.12		V

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Pin Configuration

Top View

```
FB    1        6   CS
GND   2        5   VIN
EN/SS 3        4   GATE
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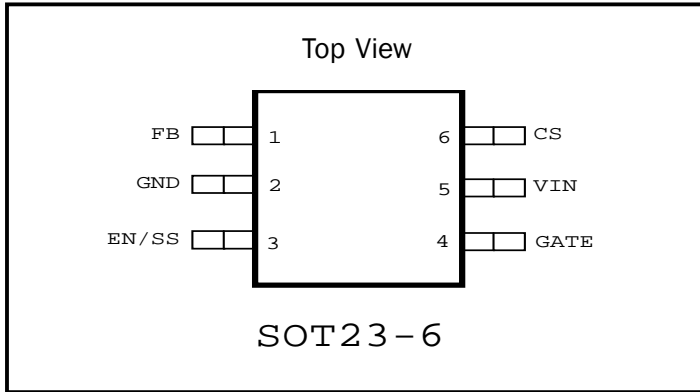
SOT23-6

Ordering Information

| Part Numbers	Package
SC2603SKTRT (1)(2)	SOT23-6
SC2603EVB	

Note:
(1) Only available in tape and reel packaging. A reel contains 3000 devices.
(2) Lead free product. This product is fully WEEE and RoHS compliant

Pin Descriptions

Pin #	Pin Name	Pin Function
1	FB	Error amplifier input (-).
2	GND	Device ground.
3	EN/SS	Enable/Soft Start Pin.
4	Gate	Gate driver output.
5	VIN	Device Input Voltage.
6	CS	Current Sense Input .

Block Diagram
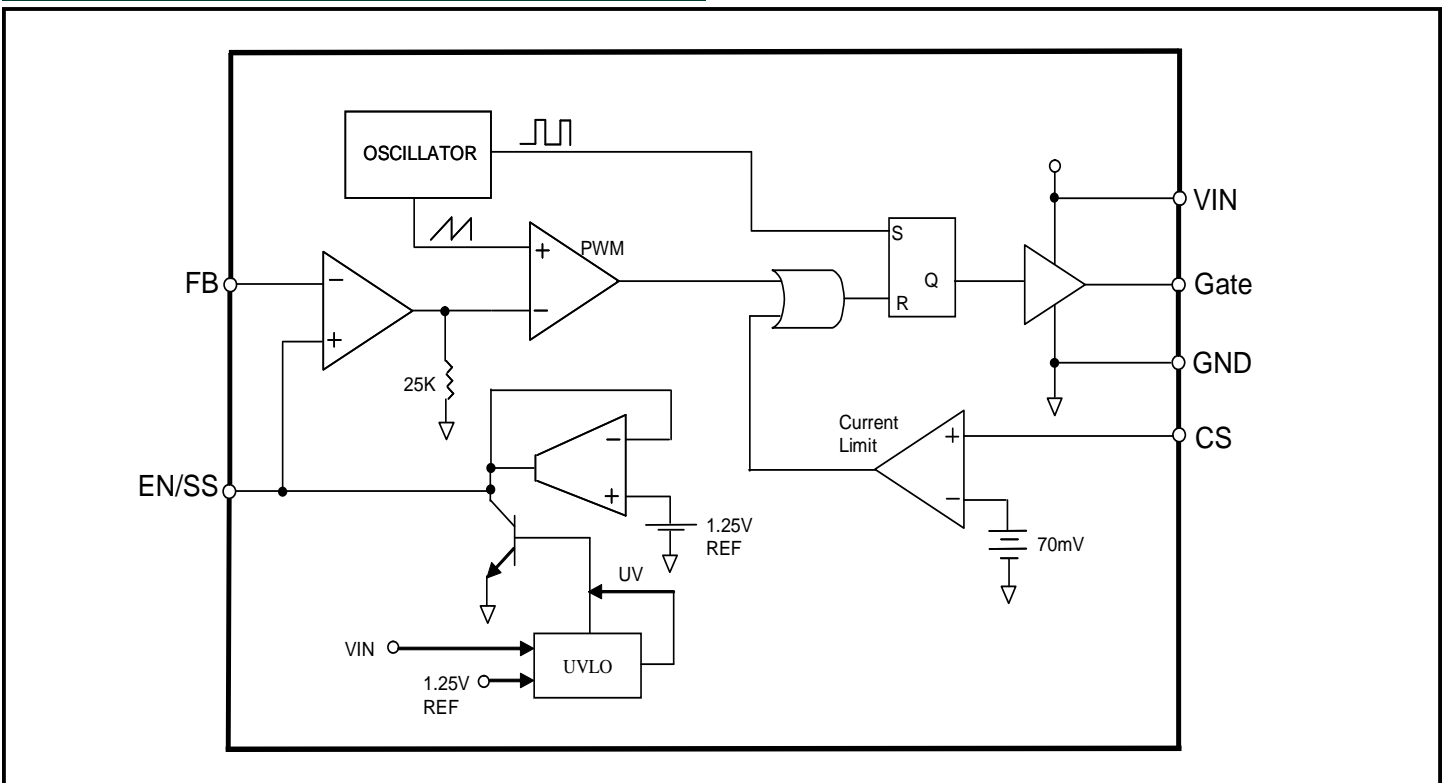
POWER MANAGEMENT

Theory of Operation

The SC2603 is a versatile, low-cost, voltage-mode PWM controller designed for DC/DC power supply applications. In normal condition, the SC2603 operats at a fixed 200KHz. One exception is that when the FB pin voltage drops to one half, the frequency will be shifted to one fouth of 200KHz.

SC2603 features include a temperature compensated voltage reference, triangle wave oscillator, current limit comparator, frequency shift over-current protection, and an internally compensated error amplifier. Pulse by pulse current limiting is implemented by sensing the differential voltage across an external resistor, or an appropriately sized PC board trace.

Application Information

Soft-Start

Soft-start prevents a DC-DC converter from drawing excessive current from the power source during start up. If the soft-start time is made sufficiently long, then the output will enter regulation without overshoot. An external capacitor is connected from the EN/SS pin to the ground. After the part's input voltage surpasses the UVLO, the EN/SS pin is allowed to charge its capacitor with 60µA. When 100mV is reached at the EN/SS pin, the internal comp node is at 0.4V. The SC2603 will start switching, and the converter output comes into regulation. Because the FB pin voltage follows EN/SS pin voltage, finally, the EN/SS pin voltage will be clamped at 1.25V same as the refernece voltage.

Setting the Output Voltage

An external resistive divider R_1 and R_2 with its center tap tied to the FB pin sets the output voltage.

$$R_1 = R_2 \left(\frac{V_{OUT}}{1.25} - 1 \right)$$
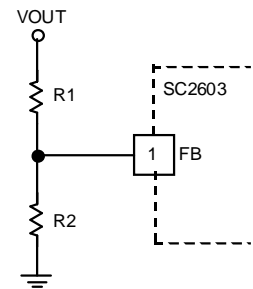
Under Voltage Lockout

The under voltage lockout circuit of the SC2603 assures that the gate driver output remains in the off state whenever the supply voltage drops below set parameters. Lockout occurs if V_{IN} falls below 3.8V. Normal operation resumes once V_{IN} rises above 4.2V.

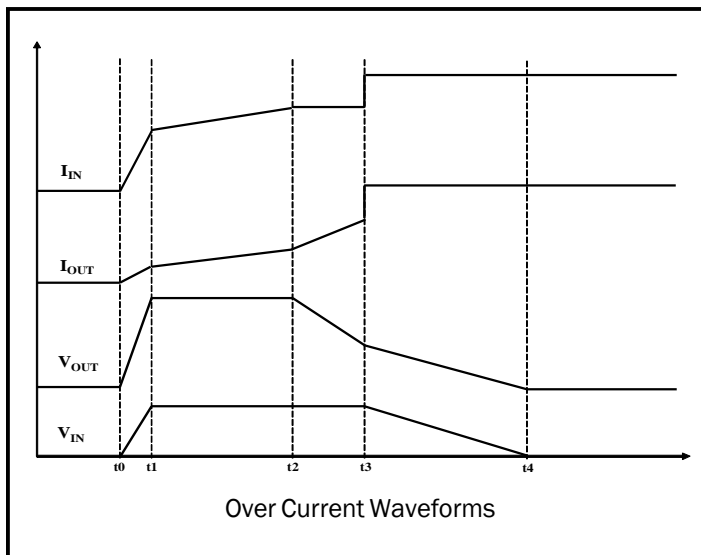## POWER MANAGEMENT
Application Information

Over Current Protection

The over-current protection is implemented by a sensing resistor and an internal current-limit comparator with a threshold of 70mV. If the switching current through the sensing resistor causing voltage to drop at the CS pin reachs 70mV, the SC2603 will immediately turn the gate pulse off to limit the current through the power switch. The figure below shows over-current waveforms. At t1, the input current I_{IN} begins to increase as the load I_{OUT} builds up until it hits the OCP threshold at t2. At t2, V_{OUT} begins to drop as I_{OUT} starts increasing toward t3 while V_{IN} and I_{IN} remain the same. At t3, there two events are happening. 1) V_{OUT} is at half of its regulating voltage. At this point, the internal oscillator runs into frequency shift mode and shifts the frequency to one fourth of the operating frequency. 2) The diode starts conducting current without limit causing V_{IN} to fall due to supply current limit. Finally, V_{IN} and V_{OUT} both drops to zero and I_{IN} becomes the input supply current limit.

A RC filter at the CS pin is necessary to filter out noise to ensure accurate sensing.
The value of the sensing resistor can be caculated by the following equation:

$$R_S = 70\,mV\ /\ I_{PEAK}$$

Where I_{PEAK} is the input peak current through the power MOSFET.

Over Current Waveforms

Layout Guidelines

Careful attention to layout requirements are necessary for successful implementation of the SC2603 PWM controller. High currents switching at 200kHz are present in the application and their effect on ground plane voltage differentials must be understood and minimized.

1) The high power parts of the circuit should be laid out first. A ground plane should be used, the number and position of ground plane interruptions should be such as to not unnecessarily compromise ground plane integrity. Isolated or semi-isolated areas of the ground plane may be deliberately introduced to constrain ground currents to particular areas, for example the input capacitor and bottom Schottky ground.

2) The loop formed by the output Capacitor(s) (Cout), the FET (Q1), the current sensing resistor, and the Schottky (D1) must be kept as small as possible. This loop contains all the high current, fast transition switching. Connections should be as wide and as short as possible to minimize loop inductance. Minimizing this loop area will reduce EMI, lower ground injection currents, resulting in electrically "cleaner" grounds for the rest of the system and minimize source ringing, resulting in more reliable gate switching signals.

3) The connection between the junction of Q1, D1 and the output capacitor should be a wide trace or copper region. It should be as short as practical. Since this connection has fast voltage transitions, keeping this connection short will minimize EMI.

4) The Output Capacitor(s) (Cout) should be located as close to the load as possible, fast transient load currents are supplied by Cout only, and connections between Cout and the load must be short, wide copper areas to minimize inductance and resistance.

5) The SC2603 is best placed over an isolated ground plane area. The soft-start capacitor, the V_{IN} decoupling capacitor, and the current sensing filter capacitor should also connected to this ground pad area. This isolated ground area should be connected to the main ground by a trace that runs from the GND pin to the ground side of the output capacitor. If this is not possible, the GND pin may be connected to the ground path between the Output Capacitor and the Cin, Q1, D1 loop. Under no circumstances should GND be returned to a ground inside the Cin, Q1, D1 loop.

6) Input voltage of the SC2603 should be supplied from the power rail through a 2.2~10Ω resistor, the V_{IN} pin should be decoupled directly to GND by a 0.1μF~1μf ceramic capacitor, trace lengths should be as short as possible.

7) An RC low pass filter is required to filter out leading edge current spikes on the current sensing resistor. The filter capacitor needs to be very close to the CS and GND to reduce noise pickup.
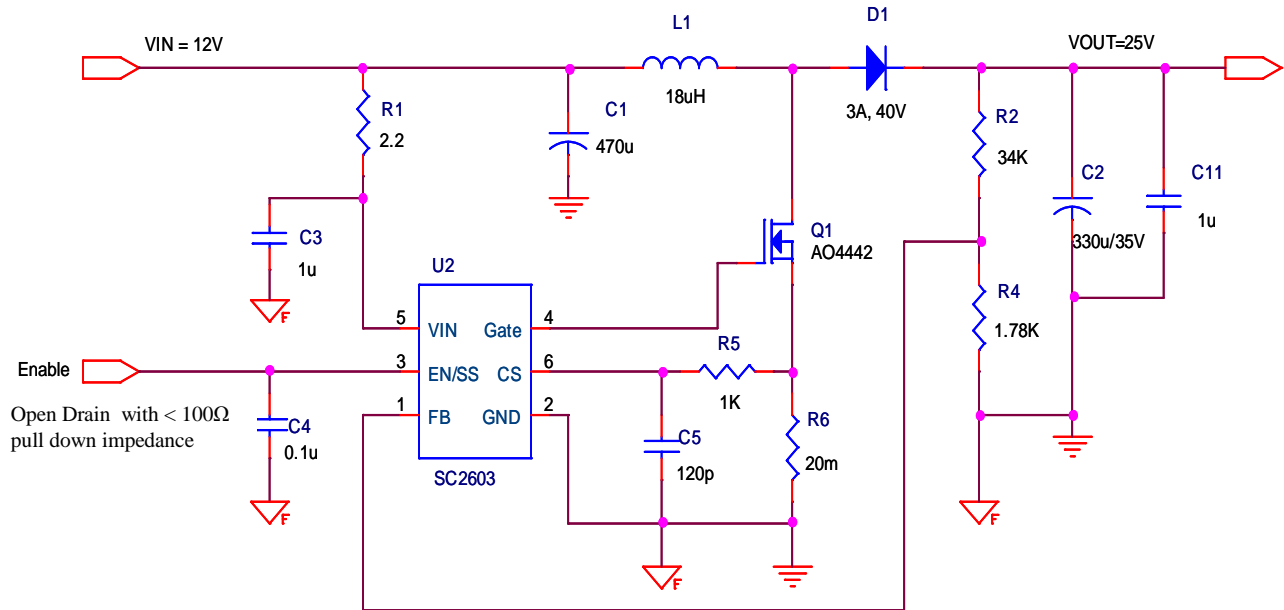
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Applications Information (Cont.)

Layout diagram for the SC2603
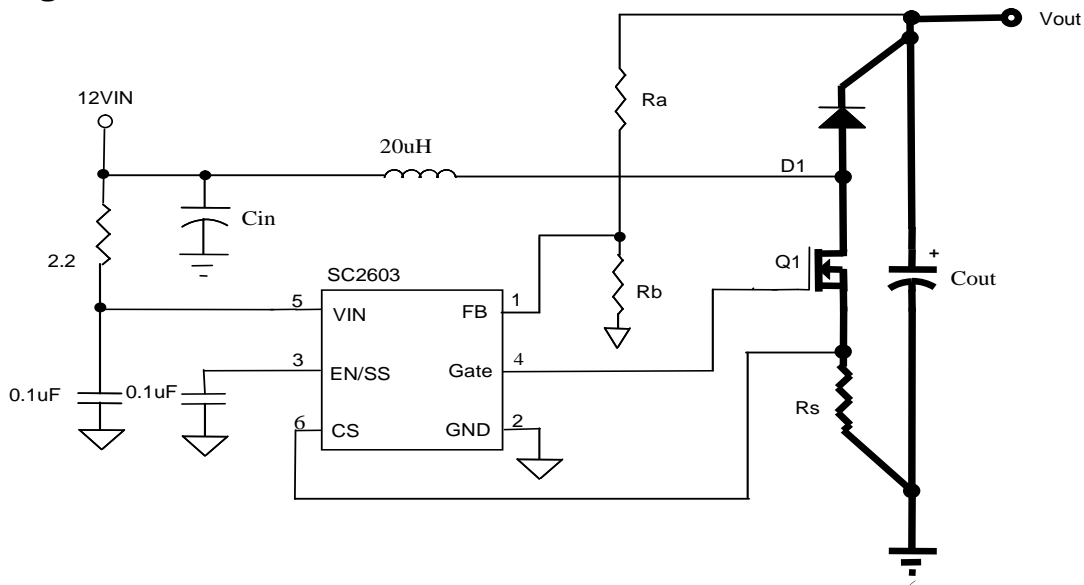
Heavy lines indicate the critical loop carrying high pulsating current.
The inductance of this loop needs to be minimized.

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POWER MANAGEMENT

Applications Circuit

12V to 25V @ 1A boost converter

VIN = 12V

L1
18uH

D1
3A, 40V

VOUT=25V

R1
2.2

C1
470u

R2
34K

C2
330u/35V

C11
1u

C3
1u

Q1
AO4442

R4
1.78K

U2

5	VIN	Gate	4
3	EN/SS	CS	6
1	FB	GND	2

SC2603

Enable

Open Drain with < 100Ω
pull down impedance

C4
0.1u

R5
1K

R6
20m

C5
120p

Bill of Material

Item	Quantity	Reference	Part	footprint	Vendor
1	1	C1	470u/Alum		SANYO
2	1	C2	330u/Alum		SANYO
3	1	C3	1uF	603	
4	1	C4	0.1u	603	
5	1	C5	120p	603	
6	1	C11	1u	805	
7	1	D1	1N5819		
8	1	L1	18uH		COOPER
9	1	Q1	AO4442		Alpha & Omega
10	1	R1	2.2	603	
11	1	R2	34K	603	
12	1	R3	0	603	
13	1	R4	1.78K	603	
14	1	R5	1K	603	
15	1	R6	20m		
16	1	U1	SC2603	SOT23-6	SEMTECH
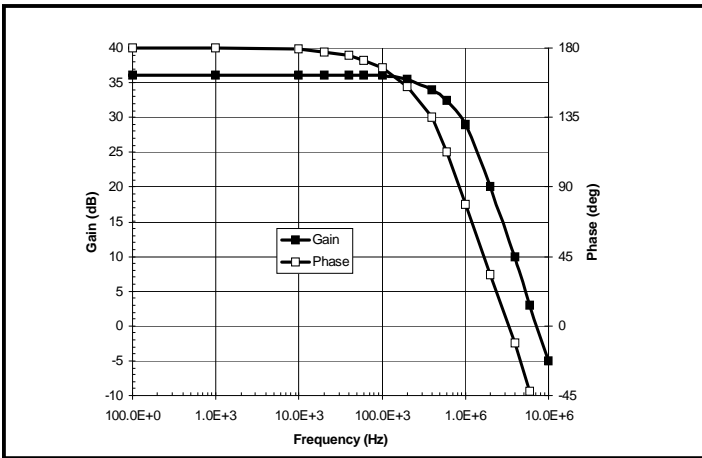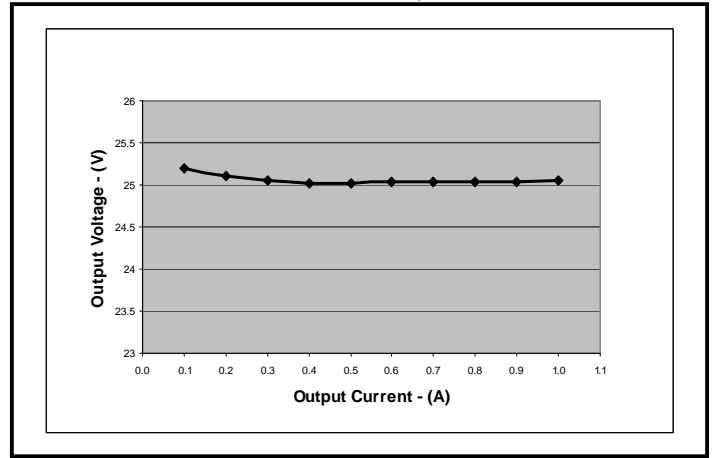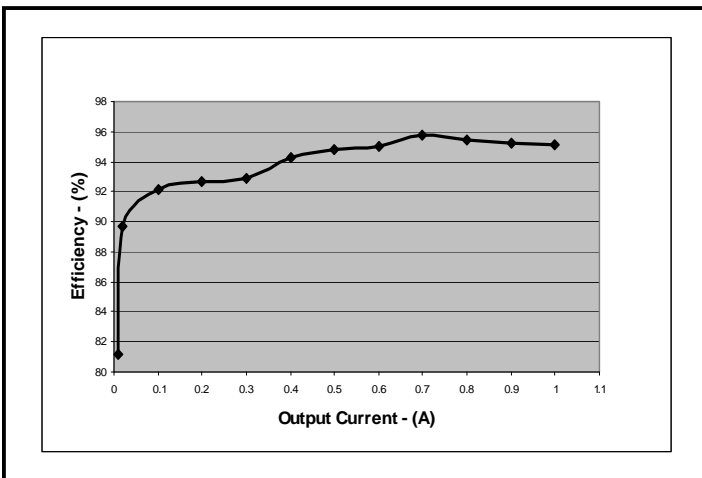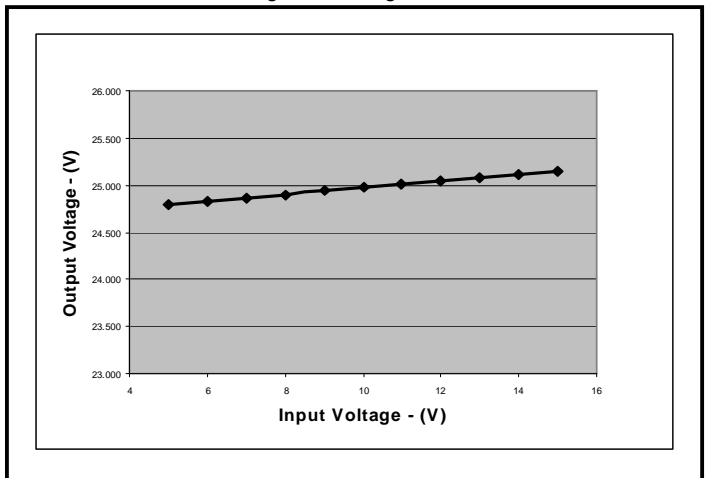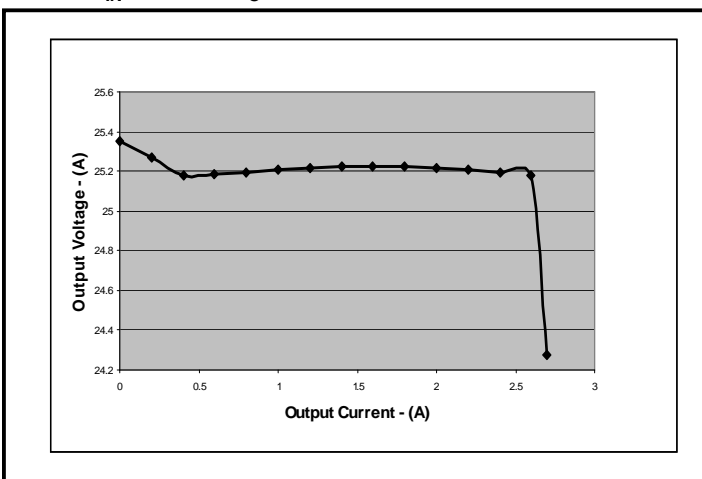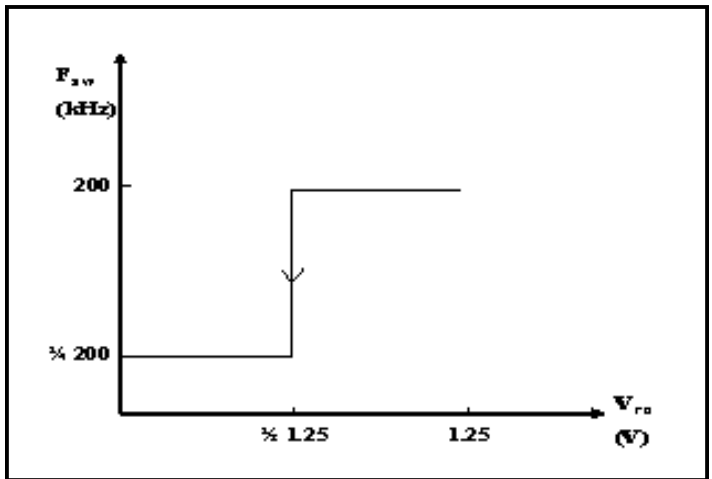
Reference Voltage vs Temperature
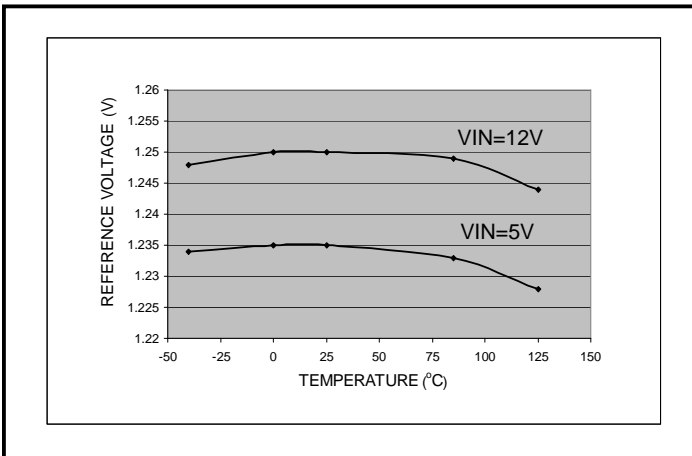
UVLO Hysteresis vs Temperature
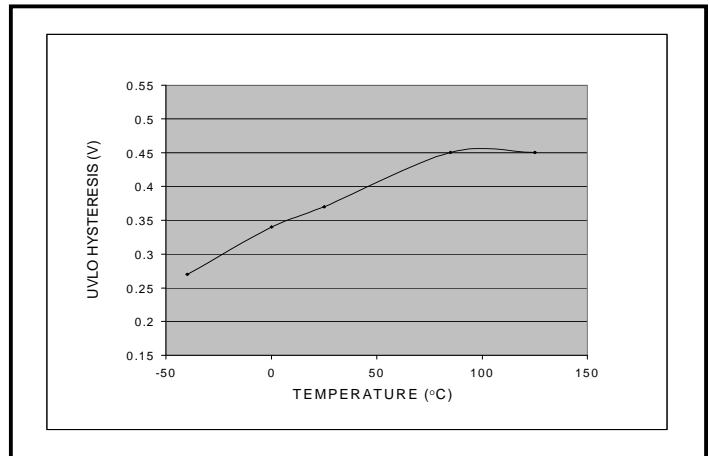
Oscillator Frequency vs Temperature

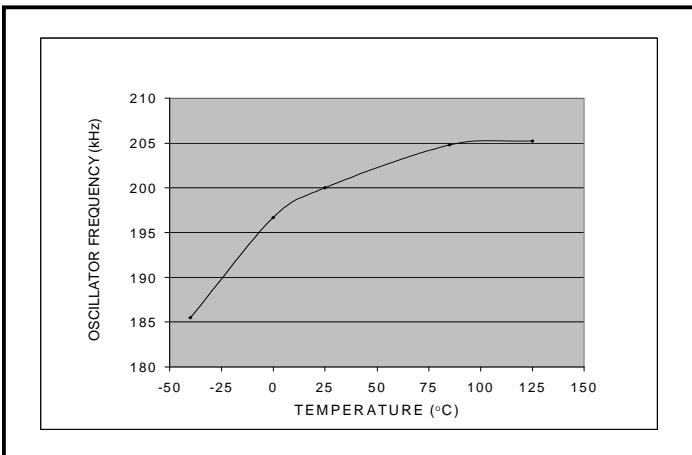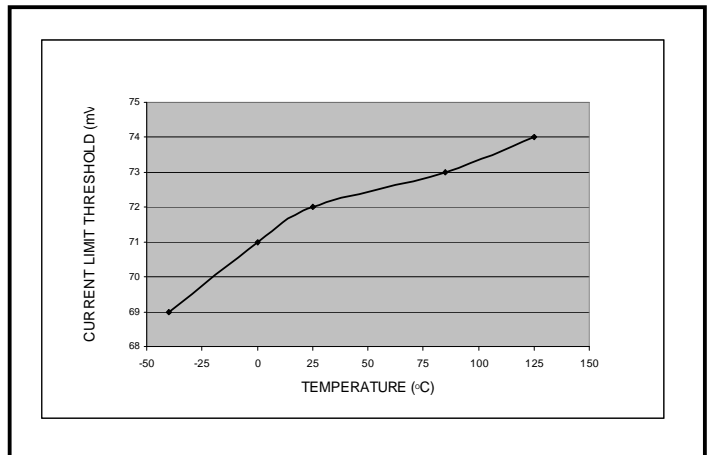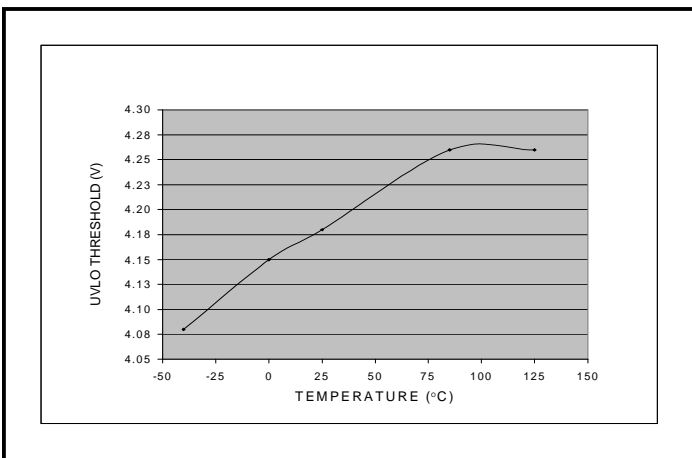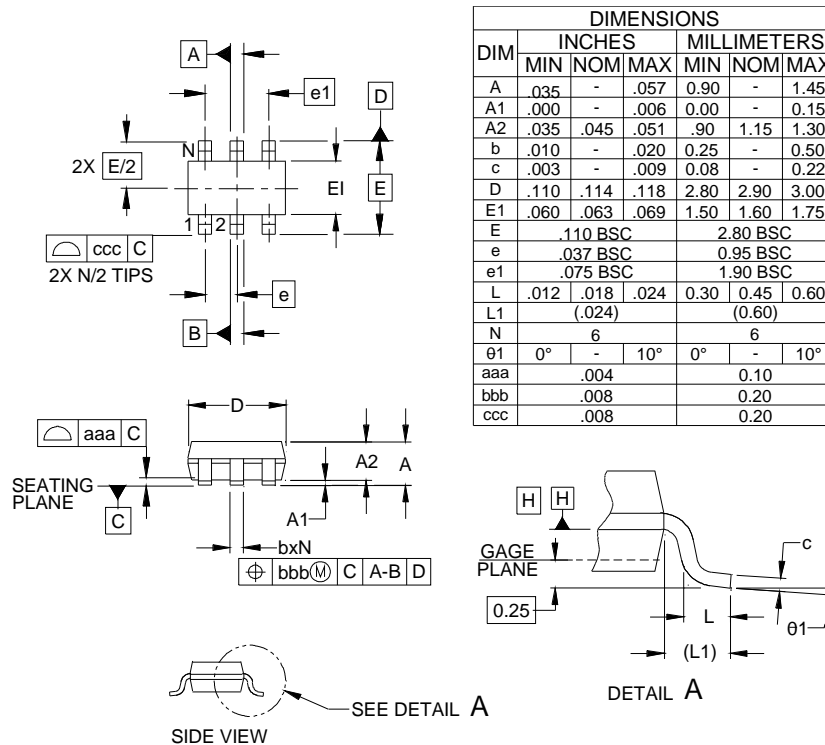## Current Limit Threshold vs Temperature

UVLO Threshold vs Temperature
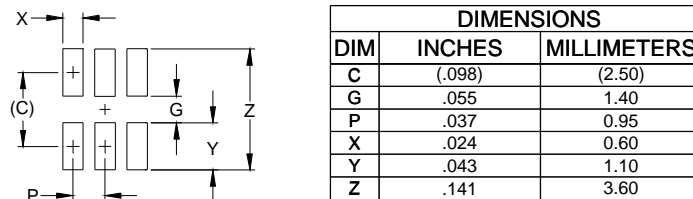
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Outline Drawing - SOT23-6

DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.035	-	.057	0.90	-	1.45
A1	.000	-	.006	0.00	-	0.15
A2	.035	.045	.051	.90	1.15	1.30
b	.010	-	.020	0.25	-	0.50
c	.003	-	.009	0.08	-	0.22
D	.110	.114	.118	2.80	2.90	3.00
E1	.060	.063	.069	1.50	1.60	1.75
E	.110 BSC			2.80 BSC		
e	.037 BSC			0.95 BSC		
e1	.075 BSC			1.90 BSC		
L	.012	.018	.024	0.30	0.45	0.60
L1	(.024)			(0.60)		
N	6			6		
θ1	0°	-	10°	0°	-	10°
aaa	.004			0.10		
bbb	.008			0.20		
ccc	.008			0.20		

DIMENSIONS

NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. DATUMS -A- AND -B- TO BE DETERMINED AT DATUM PLANE -H-
3. DIMENSIONS "E1" AND "D" DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

Land Pattern - SOT23-6

DIMENSIONS		
DIM	INCHES	MILLIMETERS
C	(.098)	(2.50)
G	.055	1.40
P	.037	0.95
X	.024	0.60
Y	.043	1.10
Z	.141	3.60

NOTES:
1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

Contact Information

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